Client Code: SDISW.057AUS

Cheon-Soo Kim

3. Nature of conveyance:

December 7, 2009

Customer No. 20,995

()

(X) Assignment

() Merger () Other:

signatures)

Address:

Yes

(X)

attached?

RECORDATION FORM COVER SHEET

PATENTS ONLY

To the Director, U.S. Patent and Trademark Office: Please record the attached original documents or copy thereof. Name and address of receiving party(ies): Name of conveying party(ies): (List using letters or numbers for multiple parties) Name: Samsung SDI Co., Ltd. Address: 673-7, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea Additional name(s) of conveying party(ies) Additional name(s) of receiving party(ies) attached? (X) No Yes () () Security Agreement () Change of Name 4. US or PCT Application number(s) or US Patent number(s): Execution Date: (List as in section 1 if multiple (X) Patent Application No.: 12/634,488 Filing Date: December 9, 2009 Additional numbers attached? (X) () Yes No 6. Total number of applications and patents 5. Party to whom correspondence concerning involved: 1 document should be mailed: Knobbe, Martens, Olson & Bear, LLP 2040 Main Street, 14<sup>th</sup> Floor Attorney's Docket No.: SDISW.057AUS

(X)

Return Fax: (949) 760-9502

7. Total fee (37 CFR 1.21(h)): \$40.00

Authorized to be charged to deposit account

8. Deposit account number: 11-1410

Please charge this account for any additional fees which may be required, or credit any overpayment to this account.

9. Statement and signature.

Irvine, CA 92614

is a true copy of the original document.

To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy

Michael H. Trenholm Name of Person Signing

Signature

12-10-09

37,743 Registration No.

Total number of pages including cover sheet, attachments and document: 2

Documents transmitted via Facsimile to be recorded with required cover sheet information to:

Mail Stop Assignment Recordation Services

Director, U.S. Patent and Trademark Office

P.O. Box 1450

Alexandria, VA 22313-1450

Facsimile Number: (571) 273-0140

8236280:lw 120909

> PATENT REEL: 023638 FRAME: 0104

700424770

CH \$40.00 111410 12634488

Application No.: Unknown Filing Date: Herewith

Client Code: SDISW.057ADS

Page 1

## ASSIGNMENT

**KMOB** 

WHEREAS, I, the undersigned have invented certain new and useful improvements in a CAP ASSEMBLY AND SECONDARY BATTERY HAVING THE SAME for which I have executed an application for Letters Patent in the United States, on even date herewith:

AND WHEREAS, Samsung SDI Co., Ltd., (hereinalter "ASSIGNEE"), with its principal place of business at 673-7, Meetan-dong, Yeongtong-gu, Suwon-st, Gyconggi-do, Republic of Korea, desires to acquire the entire right, title, and interest in and to the said improvements with-respect to the United States of America, its territories and possessions:

NOW. THEREFORE, in light of good and valuable consideration, the receipt of which is hereby acknowledged. It the said inventor, do hereby acknowledge that I have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in to and under the said improvements, and the said application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and sail reissues and extensions thereof, and all rights of priority under international Conventions and applications for Letters Patent which may hereafter be filled for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof, and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE; its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant and agree that I will communicate to the said ASSIGNEE its successors. legal representatives and assigns, any facts known to me respecting said improvements; and testify in any legal proceeding, sign all lawful papers; execute all knowledges continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE. Its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

Date: Dec. 7, 2009 Signature: Cheon Sas Kim Name: Cheon-Soo Kim

Address: clo Samsung SDI Co., Ltd: 673-7, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea

PATENT

REEL: 023638 FRAME: 0105